

PART NO. : TG22-S141NDRL

16PIN SMT 10/100BASE-TX ISOLATION MODULE
OPTIMIZED FOR AMD 79C973/5 PHY CHIPS

RoHS COMPLIANT

COMPATIBLE TO LEAD-FREE SOLDERING PROCESS
CONDITION PER IPC/JEDEC J-STD-020C

UL/EN60950 AND DEMKO RECOGNIZED

OPERATING TEMPERATURE 0/+70°C

ELECTRICAL SPECIFICATIONS @25° C

TURN RATIO

TX P16-15:P10-11

1CT:1.41CT±3%

RX P1-2:P7-6

1CT:1CT±3%

OCL (100KHz,0.1Vrms,8mA)

P7-6,P10-11

350µH min

DCR P1-2,P16-15

0.9Ω max

LL P1-2,P16-15

0.4µH max

Cw/w

20pF typ

CROSSTALK 0.1-100MHz

-40dB typ

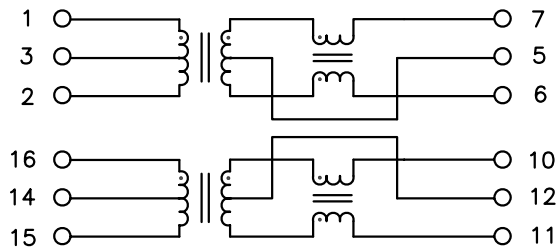
CMR 0.1-100MHz

-40dB typ

ISOLATION

1,500Vrms

DIMENSIONS: Inch[mm]
CO-PLANARITY: 0.004[0.10]
TOLERANCES: ±0.005 INCH IF NOT SPECIFIED



HALO/PBL

CALIFORNIA, USA
KOWLOON, HONG KONG
SINGAPORE

TITLE		ISOLATION MODULE		SIGNATURES		DATE	REV.	DESC.	DATE
FOR		10/100BASE-TX		DRAWN	PETER LU	5/2/07	A	FIRST ISSUE	5/2/07
PART NO.		TG22-S141NDRL		CHECKED	LEI KEONG	5/2/07			
SCALE		NONE	PAGE	1 OF 1	APPROVED	PETER LU	5/2/07		
				FILE	S141NDRL.DWG				